

< C band internally matched power GaAs FET >

MGFC44V6472

6.4 - 7.2 GHz BAND / 24W

DESCRIPTION

The MGFC44V6472 is an internally impedance-matched GaAs power FET especially designed for use in 6.4 - 7.2 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Class A operation

Internally matched to 50(ohm) systemHigh output power

- P1dB=24W (TYP.) @f=6.4 7.2GHz • High power gain
- GLP=8.0dB (TYP.) @f=6.4 7.2GHz • High power added efficiency
- P.A.E.=31% (TYP.) @f=6.4 7.2GHz • Low distortion [item -51]
- IM3=-42dBc (TYP.) @Po=33.5dBm S.C.L

APPLICATION

- item 01 : 6.4 7.2 GHz band power amplifier
- item 51 : 6.4 7.2 GHz band digital radio communication

QUALITY

• IG

RECOMMENDED BIAS CONDITIONS

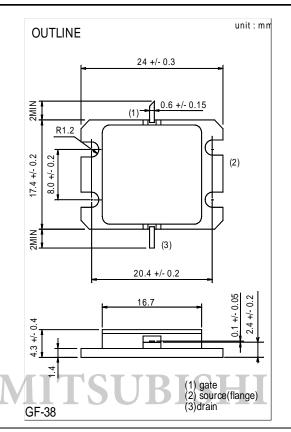
VDS=10V
ID=6.4A
RG=25ohm
Refer to Bias Procedure

Absolute maximum ratings (Ta=25°C)

Symbol	Parameter	Ratings	Unit			
VGDO	Gate to drain breakdown voltage	-15	V			
VGSO	Gate to source breakdown voltage	-15	V			
ID	Drain current	20	А			
IGR	Reverse gate current	-60	mA			
IGF	Forward gate current	126	mA			
PT *1	Total power dissipation	93	W			
Tch	Cannel temperature	175	°C			
Tstg	Storage temperature	-65 to +175	°C			
*1 • Ta-25°C						

*1 : Tc=25°C

Electrical characteristics (Ta=25°C)



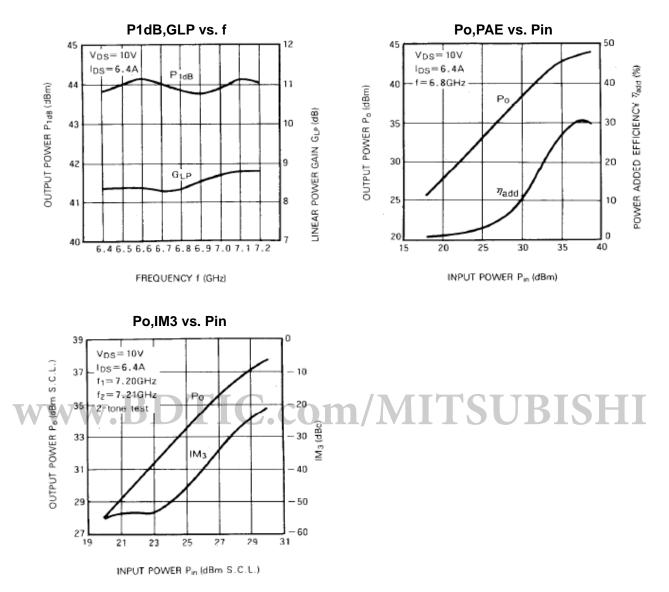
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Symbol	Parameter	Test conditions	Limits		Unit	
			Min.	Тур.	Max.	
IDSS	Saturated drain current	VDS=3V,VGS=0V	-	18	-	А
gm	Transconductance	VDS=3V,ID=6.4A	-	6.5	-	S
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=120mA	-2	-	-5	V
P1dB	Output power at 1dB gain compression	VDS=10V,ID(RF off)=6.4A	43	44	-	dBm
GLP	Linear Power Gain	f=6.4 – 7.2GHz	7	8	-	dB
P.A.E.	Power added efficiency		-	31	-	%
IM3 *2	3rd order IM distortion		-42	-	-	dBc
Rth(ch-c) *3	Thermal resistance		-	-	1.6	°C/W

*2 :item -51 ,2 tone test,Po=33.5dBm Single Carrier Level ,f=7.2GHz,delta f=10MHz

*3 :Channel-case

MGFC44V6472 TYPICAL CHARACTERISTICS (Ta=25deg.C)



MGFC44V6472 S-parameters(Ta=25deg.C , VDS=10(V),IDS=6.4(A))

f (GHz)	S Parameters(Typ.)							
	S11		S21		S12		S22	
	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)
6.4	0.55	81	2.46	-124	0.039	-168	0.33	67
6.5	0.51	62	2.52	-141	0.042	173	0.35	71
6.6	0.46	43	2.49	-157	0.051	157	0.32	63
6.7	0.41	25	2.58	-174	0.054	138	0.32	51
6.8	0.37	3	2.60	169	0.062	126	0.31	29
6.9	0.33	-16	2.62	152	0.065	105	0.26	30
7.0	0.28	-37	2.64	136	0.071	91	0.22	16
7.1	0.26	-55	2.68	125	0.071	84	0.19	8
7.2	0.19	-91	2.65	107	0.076	65	0.13	0

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